

Quad-Row Board-to-Board Connectors

Quad-Row Board-to-Board Connectors feature a staggered circuit layout for a highly compact package in a wide range of space-constrained applications, allowing manufacturers to maximize productivity while minimizing the physical footprint. These connectors offer robust power for enhanced overall efficiency and meet market demands without compromising functionality.

ADVANTAGES AND FEATURES

Offers excellent space savings

The low-profile design has a 0.175mm-pitch.

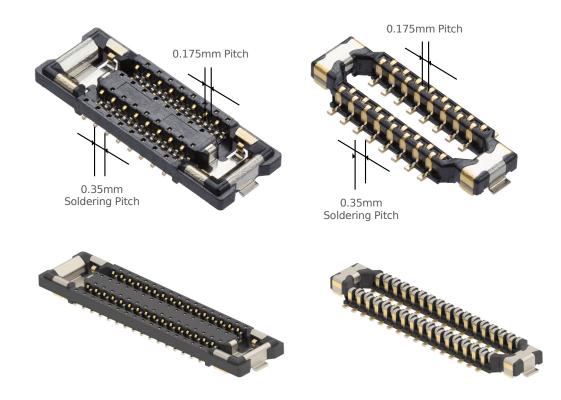
Provides robustness and protection in the interior cover

An armored and insert-molded nail helps prevent damage to the connectors.

Simplifies the system design and increases functionality for enhanced performance and capabilities

More circuits are incorporated into a single connector, reducing the number of connectors needed.

Current	3.0/4.0A					
Voltage	50V					
Circuits	12 to 80					
Pitch	0.175mm					
Height	0.50/0.60/0.80mm					
Operating Temperature	-40 to +85°C					





Quad-Row Board-to-Board Connectors

MARKETS AND APPLICATIONS

Home Appliances

IoT and smart home devices

MedTech

Patient-monitoring systems
Therapeutic and surgical equipment

Defense

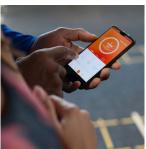
Unmanned vehicles
Aircraft avionics

Mobile Devices

Smart phones Tablets

Wearables

Smart watches Smart glasses Earbuds AR/VR devices



Smart Phones





Smart Watches

Patient-Monitoring Systems

SPECIFICATIONS

Reference Information

Packaging: Embossed tape with cover Designed In: Millimeters RoHS: Yes

Halogen Free: Yes

Contact Resistance:

Electrical

Voltage (max.): 50V Current (max.): 0.3A signal; 3.0/4.0A nail

Signal Contact: 35 milliohms Nail Contact: 20 milliohms Dielectric Withstanding Voltage: 250V Insulation Resistance: 100 megohms

Mechanical

Pitch: 0.175mm

Mated Height: 0.50/0.60/0.80mm

Width: 2.00mm

Length (Receptacle):
Pitch (N/2-1)+3.10mm

Structure Type: vertical type
Circuit Sizes: 12 to 80 circuits

Durability (max.): 30 cycles

Physical

Housing: LCP UL94 V-0
Contact: Copper alloy
Plating: Contact Area—gold
Solder Tail Area—gold
Underplating—nickel
Operating Temperatures: -40 to +85°C

QUAD-ROW CONNECTOR LINEUPS

Coming SoonSample Available

Height (mm)		Current Size																
	12	16	20	24	28	32	36	40	44	48	52	56	60	64	68	72	76	80
0.50	0		0															
0.60			•	0		•	•		•					•				0
0.80											0							

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